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Texas Instruments SN74ALS29827DW

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Distributor of Texas Instruments: Excellent Integrated System Limited Datasheet of SN74ALS29827DW - IC BUFF/DVR N-INV 24SOIC Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

SN74ALS29827, SN74ALS29828 10-BIT BUFFERS AND BUS DRIVERS WITH 3-STATE OUTPUTS SDAS095B – JANUARY 1986 – REVISED JANUARY 1995

	SDAS095B – JANUARY 1986 – REVIS			
 Functionally Equivalent to AMD's AM29827 and AM29828 	DW OR NT PACKAGE (TOP VIEW)			
 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers 	$\begin{array}{c c} \hline OE1 & \hline 1 & 24 \\ \hline A1 & 2 & 23 \\ \hline Y1 \end{array}$			
• pnp Inputs Reduce dc Loading	$\begin{array}{ccc} A & U & 2 \\ A & 2 & 1 \\ A & 2 & 1 \\ \end{array}$			
 Data Flow-Through Pinout (All Inputs on Opposite Side From Outputs) 	A3 [] 4 21 [] Y3 A4 [] 5 20 [] Y4			
 Power-Up High-Impedance State 	A5 6 19 Y5			
Package Options Include Plastic	A6 🛛 7 18 🗋 Y6			
Small-Outline (DW) Packages and Standard	A7 🛛 8 17 🗋 Y7			
Plastic (NT) 300-mil DIPs	A8 🛛 9 🛛 16 🗋 Y8			
	A9 🛛 10 🛛 15 🗖 Y9			
description	A10 🛛 11 🛛 14 🗖 Y10			
These 10-bit buffers and bus drivers provide	GND [12 13] OE2			

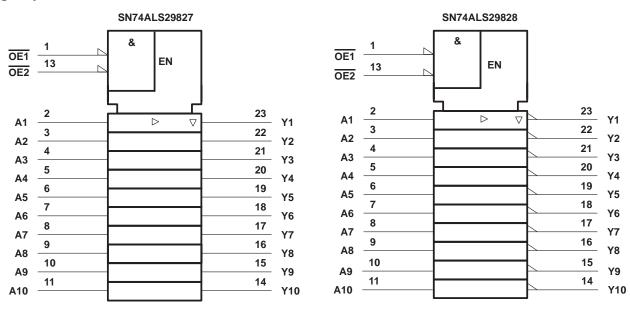
These 10-bit buffers and bus drivers provide high-performance bus interface for wide data paths or buses carrying parity.

The 3-state control gate is a 2-input NOR such that if either output-enable ($\overline{OE1}$ or $\overline{OE2}$) input is high, all ten outputs are in the high-impedance state.

The SN74ALS29827 provides true data and the SN74ALS29828 provides inverted data at their respective outputs.

The SN74ALS29827 and SN74ALS29828 are characterized for operation from 0°C to 70°C.

logic symbols[†]



[†] These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

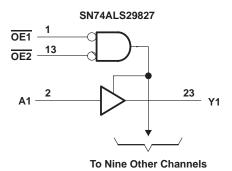


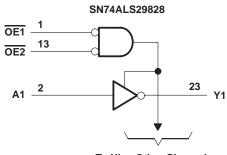


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SN74ALS29827, SN74ALS29828 10-BIT BUFFERS AND BUS DRIVERS WITH 3-STATE OUTPUTS SDAS095B – JANUARY 1986 – REVISED JANUARY 1995

logic diagrams (positive logic)





To Nine Other Channels

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC}	
Input voltage, V _I	5.5 V
Voltage applied to a disabled 3-state output	5.5 V
Operating free-air temperature range, T _A	0°C to 70°C
Storage temperature range	-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN74ALS29827 SN74ALS29828			UNIT	
		MIN	NOM	MAX		
Vcc	Supply voltage	4.75	5	5.25	V	
VIH	High-level input voltage	2			V	
VIL	Low-level input voltage			0.8	V	
IOH	High-level output current			-24	mA	
IOL	Low-level output current			48	mA	
ТА	Operating free-air temperature	0		70	°C	





SN74ALS29827, SN74ALS29828 10-BIT BUFFERS AND BUS DRIVERS WITH 3-STATE OUTPUTS SDAS095B – JANUARY 1986 – REVISED JANUARY 1995

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CON		SN74ALS29827 SN74ALS29828			
			MIN	түр†	MAX	
VIK	V _{CC} = 4.75 V,	l _l = – 18 mA			-1.2	V
Mari		I _{OH} = -15 mA				V
VOH	V _{CC} = 4.75 V	I _{OH} = -24 mA	2			v
V _{OL}	V _{CC} = 4.75 V,	I _{OL} = 48 mA		0.35	0.5	V
IOZH	V _{CC} = 5.25 V,	V _O = 2.4 V			20	μΑ
IOZL	V _{CC} = 5.25 V,	$V_{O} = 0.4 V$			-20	μΑ
li	V _{CC} = 5.25 V,	V _I = 5.5 V			0.1	mA
IIH	V _{CC} = 5.25 V,	V _I = 2.7 V			20	μA
١ _{١L}	V _{CC} = 5.25 V,	V _I = 0.4 V			-0.1	mA
los‡	V _{CC} = 5.25 V,	$V_{O} = 0$	-75		-250	mA
ICC	V _{CC} = 5.25 V			25	40	mA

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[‡] Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

switching characteristics (see Figure 1)

		TO (OUTPUT)		V _{CC} = 4.75		
PARAMETER	FROM (INPUT)		TEST CONDITIONS	SN74ALS29827	SN74ALS29828	UNIT
				MIN MAX	MIN MAX	
^t PLH	А	X	0 000 - 5	15	14	20
^t PHL	A	Y	C _L = 300 pF	15	14	ns
^t PLH	А	V	0 50 - 5	8	7	20
^t PHL	A	Y	C _L = 50 pF	8	7.5	ns
^t PZH		V	C _L = 300 pF	20	20	ns
^t PZL	OE	Y		23	23	
^t PZH	PZH <u>OE</u> Y	X	$C_{1} = 50 \text{ pF}$	15	15	ns
^t PZL	OE	Ŷ	C _L = 50 pF	15	15	115
^t PHZ	OE	Y	C _L = 50 pF	17	17	ns
^t PLZ	UE			12	12	115
^t PHZ	ŌĒ	Y	C _L = 5 pF	9	9	ns
^t PLZ	UE UE	1	0 <u>L</u> = 5 pF	9	9	115

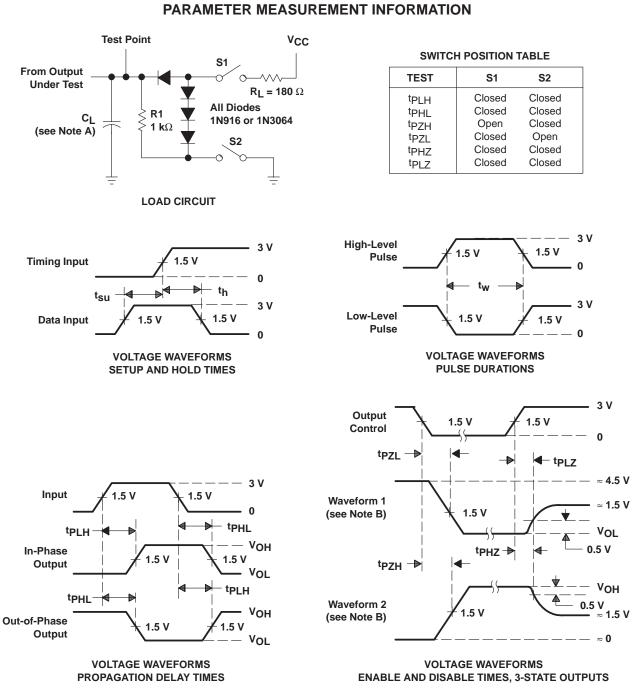




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SN74ALS29827, SN74ALS29828 **10-BIT BUFFERS AND BUS DRIVERS** WITH 3-STATE OUTPUTS

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NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control. C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_f \leq 2.5 ns, t_f \leq 2.5 ns.

Figure 1. Load Circuit and Voltage Waveforms





15-Oct-2015

PACKAGING INFORMATION

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Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN74ALS29827DW	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS29827	Samples
SN74ALS29827DWG4	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS29827	Samples
SN74ALS29828DW	OBSOLETE	SOIC	DW	24		TBD	Call TI	Call TI	0 to 70		
SN74ALS29828DWR	OBSOLETE	SOIC	DW	24		TBD	Call TI	Call TI	0 to 70		
SN74ALS29828NT	OBSOLETE	PDIP	NT	24		TBD	Call TI	Call TI	0 to 70		

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs. LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): This terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. Pb-Free (RoHS): This temponent is otherwise considered Pb-Free (RoHS compatible) as defined above. Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width

Addendum-Page 1



15-Oct-2015

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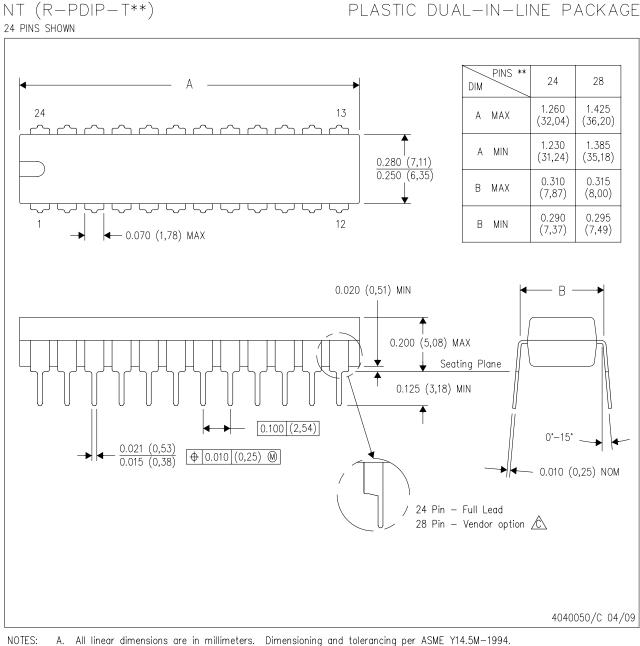
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Addendum-Page 2



MECHANICAL DATA

PLASTIC DUAL-IN-LINE PACKAGE



Β.

This drawing is subject to change without notice. The 28 pin end lead shoulder width is a vendor option, either half or full width.

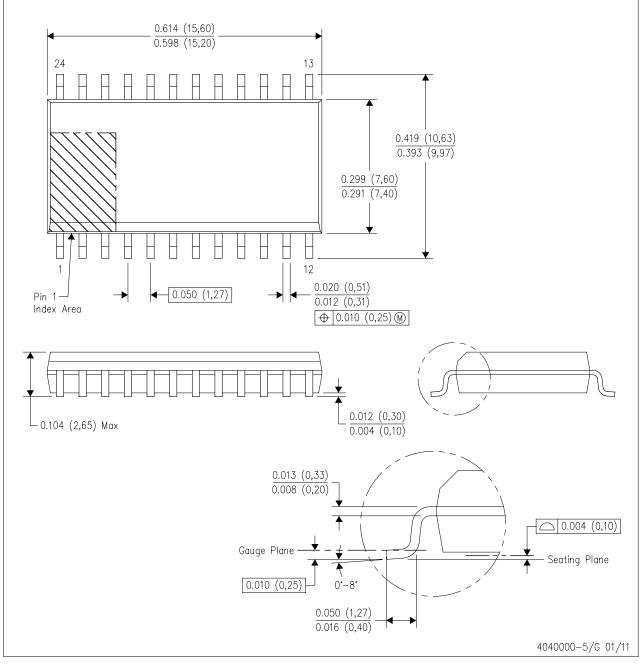




MECHANICAL DATA

DW (R-PDSO-G24)

PLASTIC SMALL OUTLINE



NOTES:

A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.
 B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-013 variation AD.





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